

New Product

N-Channel 30-V (D-S) MOSFET

| PRODUCT SUMMARY | | | | |
|---------------------|----------------------------------|--------------------|--|--|
| V _{DS} (V) | $r_{DS(on)}(\Omega)$ | I _D (A) | | |
| 30 | 0.0125 at V _{GS} = 10 V | 11 | | |
| | 0.014 at V _{GS} = 4.5 V | 10 | | |

FEATURES

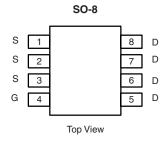
• TrenchFET® Gen II Power MOSFET



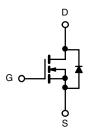
RoHS

APPLICATIONS

- High-Side DC/DC Conversion
 - Notebook
 - Desktop
 - Server
- Notebook Logic DC/DC, Low-Side



Ordering Information: Si4348DY-T1-E3 (Lead (Pb)-free)



N-Channel MOSFET

| ABSOLUTE MAXIMUM RATINGS $T_A = 25$ °C, unless otherwise noted | | | | | | |
|---|------------------------|-----------------------------------|-------------|--------------|------|--|
| Parameter | | Symbol | 10 sec | Steady State | Unit | |
| Drain-Source Voltage | | V _{DS} | 30 | | V | |
| Gate-Source Voltage | | V _{GS} | ± 12 | | | |
| Continuous Ducis Comment /T 450 9008 | T _A = 25 °C | - I _D | 11 | 8.0 | | |
| Continuous Drain Current (T _J = 150 °C) ^a | T _A = 70 °C | | 8.9 | 6.5 | | |
| Pulsed Drain Current | | I _{DM} | 40 | | Α | |
| Continuous Source Current (Diode Conduction) ^a | | I _S | 2.2 | 1.20 | | |
| Maximum Power Dissipation ^a | T _A = 25 °C | - P _D | 2.5 | 1.31 | W | |
| | T _A = 70 °C | | 1.6 | 0.84 | VV | |
| Operating Junction and Storage Temperature Range | | T _J , T _{stg} | - 55 to 150 | | °C | |

| THERMAL RESISTANCE RATINGS | | | | | |
|--|--------------|-------------------|---------|---------|------|
| Parameter | | Symbol | Typical | Maximum | Unit |
| Mariana baratian ta Ambianta | t ≤ 10 sec | R _{thJA} | 43 | 50 | °C/W |
| Maximum Junction-to-Ambient ^a | Steady State | | 74 | 95 | |
| Maximum Junction-to-Foot (Drain) | Steady State | | 19 | 25 | |

Notes:

a. Surface Mounted on 1" x 1" FR4 Board.

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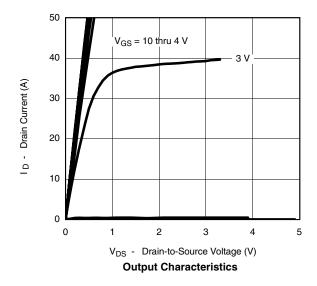
| Parameter | Symbol | Test Conditions | Min | Тур | Max | Unit | |
|---|---------------------|--|-----|------|--------|------|--|
| Static | | | | • | | | |
| Gate Threshold Voltage | V _{GS(th)} | $V_{DS} = V_{GS}, I_{D} = 250 \mu A$ | 0.8 | | 2.0 | V | |
| Gate-Body Leakage | I _{GSS} | $V_{DS} = 0 \text{ V}, V_{GS} = \pm 12 \text{ V}$ | | | ± 100 | nA | |
| Zero Gate Voltage Drain Current | I _{DSS} | V _{DS} = 30 V, V _{GS} = 0 V | 1 | | 1 | | |
| | | $V_{DS} = 30 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 55 ^{\circ}\text{C}$ | | | 5 | μΑ | |
| On-State Drain Current ^a | I _{D(on)} | $V_{DS} \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$ | 30 | | | Α | |
| Drain-Source On-State Resistance ^a | r _{DS(on)} | V _{GS} = 10 V, I _D = 11 A | | | 0.0125 | Ω | |
| | | $V_{GS} = 4.5 \text{ V}, I_D = 10 \text{ A}$ | | | 0.014 | | |
| Forward Transconductance ^a | 9 _{fs} | V _{DS} = 15 V, I _D = 11 A | | 40 | | S | |
| Diode Forward Voltage ^a | V_{SD} | I _S = 2.2 A, V _{GS} = 0 V | | 0.75 | 1.1 | V | |
| Dynamic ^b | , | | " | | | | |
| Total Gate Charge | Qg | | | 15 | 23 | | |
| Gate-Source Charge | Q_{gs} | $V_{DS} = 15 \text{ V}, V_{GS} = 4.5 \text{ V}, I_{D} = 11 \text{ A}$ | | 5 | | nC | |
| Gate-Drain Charge | Q_{gd} | | | 4.3 | | | |
| Gate Resistance | R_g | | | 0.5 | | Ω | |
| Turn-On Delay Time | t _{d(on)} | | | 10 | 15 | | |
| Rise Time | t _r | V_{DD} = 15 V, R_L = 15 Ω | | 11 | 17 | | |
| Turn-Off Delay Time | t _{d(off)} | $I_D \cong$ 1 A, V_{GEN} = 10 V, R_g = 6 Ω | | 55 | 85 | ns | |
| Fall Time | t _f | | | 9 | 15 | | |
| Source-Drain Reverse Recovery Time | t _{rr} | I _F = 2.2 A, di/dt = 100 A/μs | | 22 | 35 | | |

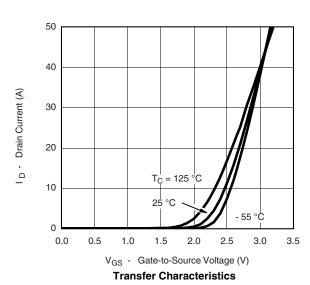
Notes:

- a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %.
- b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



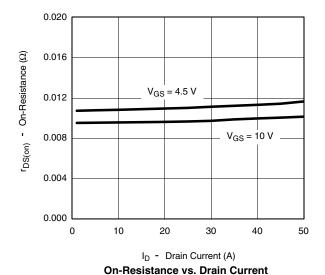


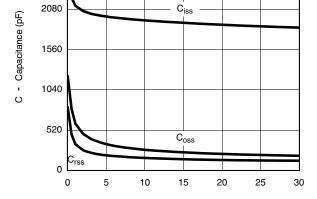






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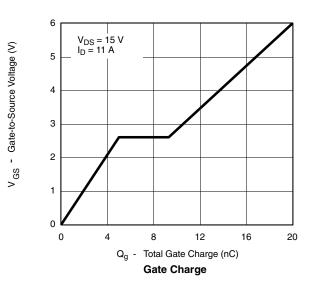


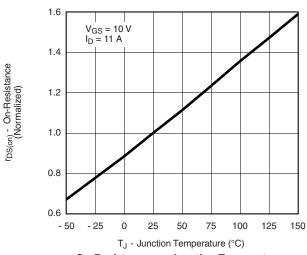


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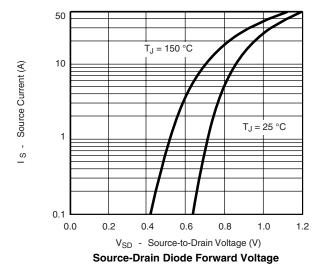
V_{DS} - Drain-to-Source Voltage (V)

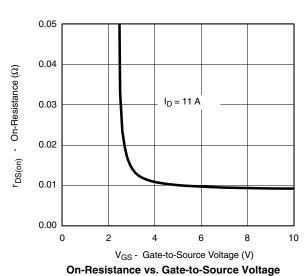
Capacitance





On-Resistance vs. Junction Temperature

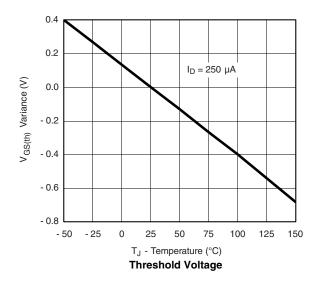


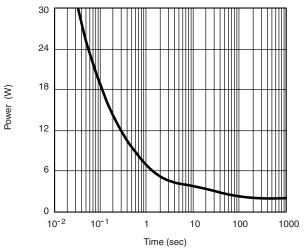


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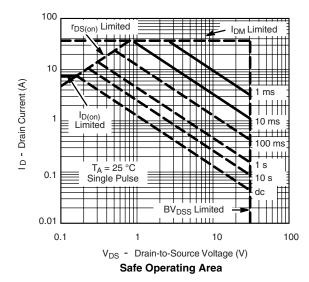
VISHAY

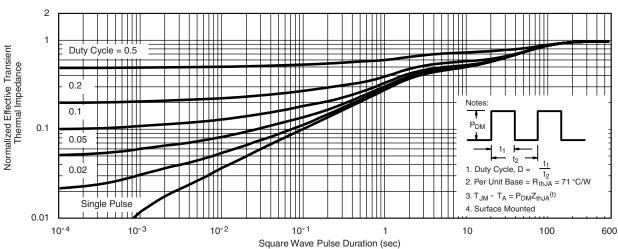
TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted





Single Pulse Power, Junction-to-Ambient

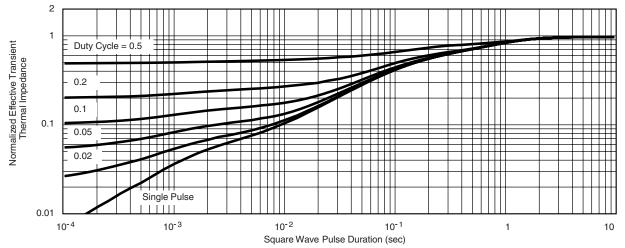




Normalized Thermal Transient Impedance, Junction-to-Ambient



TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



Normalized Thermal Transient Impedance, Junction-to-Foot

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